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omissions -- Immediate afterthoughts -- The correspondent --
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Sommario/riassunto

Author of Nazi Paris, a Choice Academic Book of the Year, Allan Mitchell has researched a companion volume concerning the acclaimed and controversial German author Ernst Junger who, if not the greatest German writer of the twentieth century, certainly was the most controversial. His service as a military officer during the occupation of Paris, where his principal duty was to mingle with French intellectuals such as Jean Cocteau and with visiting German celebrities like Martin Heidegger, was at the center of disputes concerning his career. Spending more than three years in the Frenc

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Sommario/riassunto

This book describes in clear understandable language the three main disciplines of adhesion technology: mechanics of the adhesive bond; chemistry of adhesives; and surface science. Some knowledge of physical and organic chemistry is assumed but no familiarity with the science of adhesion is required.
